



InGaAs PIN photodiodes

G11193 series

Small package, surface mount type

Features

- Small SMD (surface mount device) package
- **■** Low noise, low dark current
- Low price

Applications

- Optical power meter
- Measurement/analytical instruments

Structure

Parameter	G11193-02R	G11193-03R	G11193-10R	Unit			
Package	SMD						
Photosensitive area	ф0.2	ф0.3	φ1.0	mm			
Window	Resin						

- Absolute maximum ratings

Parameter	Symbol	Condition	G11193-02R	G11193-03R	G11193-10R	Unit			
Reverse voltage	V _R Max.		10						
Operating temperature	Topr	No dew condensation*1		-25 to +85					
Storage temperature	Tstg	No dew condensation*1	-40 to +100						
Reflow soldering conditions	-		Peak temperature 240 °C, one time						

^{*1:} When there is a temperature difference between a product and the surrounding area in high humidity environment, dew condensation may occur on the product surface. Dew condensation on the product may cause deterioration in characteristics and reliability.

Electrical and optical characteristics (Ta=25 °C)

Parameter	Symbol	Condition	G11193-02R		G11193-03R			G11193-10R			Lloit	
			Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Unit
Spectral response range	λ	Higher than 10% of peak	-	0.9 to 1.7	-	-	0.9 to 1.7	-	-	0.9 to 1.7	-	μm
Peak sensitivity wavelength	λр		-	1.55	-	-	1.55	-	1	1.55	-	μm
Photo sensitivity	S	λ=1.3 μm	0.75	0.85	-	0.75	0.85	-	0.75	0.85	-	A/W
		λ=1.55 μm	0.77	1.0	-	0.77	1.0	-	0.77	1.0	-	
Dark current	ID	V _R =5 V	-	40	800	-	100	1200	-	800	4000	pА
Temperature coefficient of dark current	ΔTid	V _R =1 V	-	1.09	-	-	1.09	-	-	1.09	-	times/°C
Cut-off frequency	fc	$V_R=5$ V, $R_L=50$ Ω , -3 dB	0.6	1	-	0.2	0.5	-	0.025	0.06	-	GHz
Terminal capacitance	Ct	V _R =5 V, f=1 MHz	-	3	5	-	5	8	-	55	120	pF
Shunt resistance	Rsh	V _R =10 mV	0.25	1.4	-	0.2	1	-	0.025	0.125	-	GΩ
Detectivity	D*	λ=λρ	1×10^{12}	5×10^{12}	-	1×10^{12}	5×10^{12}	-	1×10^{12}	5×10^{12}	-	cm·Hz ^{1/2} /W
Noise equivalent power	NEP	λ=λρ	-	3 × 10 ⁻¹⁵	1 × 10 ⁻¹⁴	-	4 × 10 ⁻¹⁵	1 × 10 ⁻¹⁴	-	1.4 × 10 ⁻¹⁴	4 × 10 ⁻¹⁴	W/Hz ^{1/2}

The G11193 series may be damaged by electrostatic discharge, etc. Be careful when using the G11193 series.

Note: Exceeding the absolute maximum ratings even momentarily may cause a drop in product quality. Always be sure to use the product within the absolute maximum ratings.

Spectral response

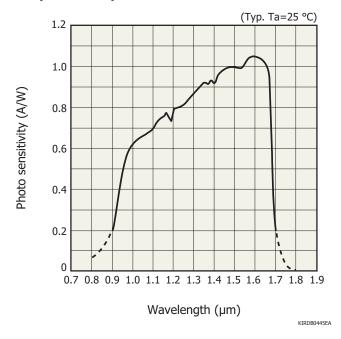
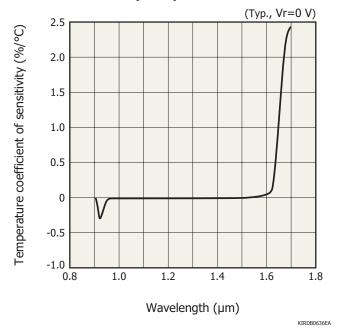
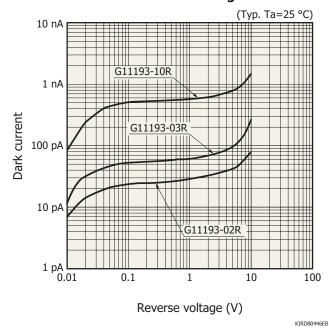


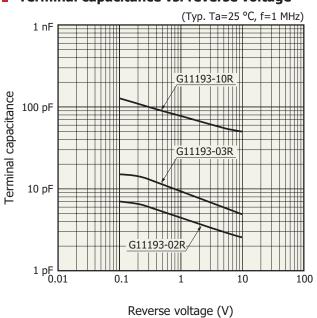
Photo sensitivity temperature characteristic



- Dark current vs. reverse voltage

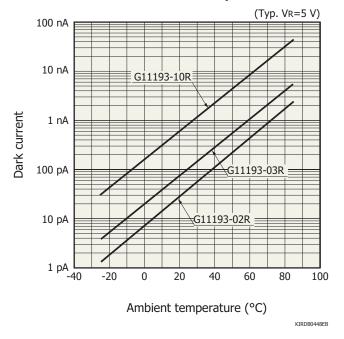


Terminal capacitance vs. reverse voltage

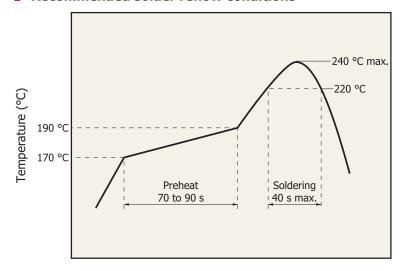


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Dark current vs. ambient temperature



- Recommended solder reflow conditions



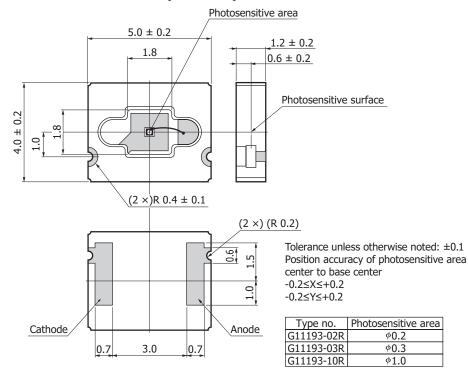
Time

- After unpacking, store the device in an environment at a temperature range of 5 to 30 °C and a humidity of 60% or less, and perform reflow soldering within 1 year.
- Therminal stress applied to the device during reflow soldering differs depending on the PC board and reflow oven being used.
- · When setting the reflow conditions, make sure that the reflow soldering process does not degrade device reliability.

KIRDB0627EA



Dimensional outline (unit: mm)



KIRDA0210EC

Related information

www.hamamatsu.com/sp/ssd/doc_en.html

- Precautions
- · Disclaimer
- · Safety consideration
- · Surface mount type products
- Technical information
- · Infrared detectors

Information described in this material is current as of November 2017.

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